ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,



ON Semiconductor®

FDMA430NZ

Single N-Channel 2.5V Specified PowerTrench® MOSFET

30V, **5.0A**, **40m**Ω

General Description

This Single N-Channel MOSFET has been designed using ON Semiconductor's advanced Power Trench process to optimize the $R_{DS}(on)$ @ V_{GS} =2.5V on special MicroFET leadframe.

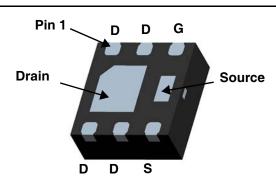
Applications

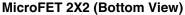
■ Li-Ion Battery Pack



Features

- $R_{DS(on)} = 40 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{ V}$, $I_D = 5.0 \text{A}$
- $R_{DS(on)} = 50m\Omega$ @ $V_{GS} = 2.5 \text{ V}$, $I_D = 4.5 \text{A}$
- Low Profile-0.8mm maximum-in the new package MicroFET 2x2 mm
- HBM ESD protection level > 2.5kV typical (Note 3)
- Free from halogenated compounds and antimony oxides
- RoHS Compliant





S 4 3 G D 5 D 6 D 1 D Bottom Drain Contact

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{DSS}	Drain-Source Voltage		30	V
V_{GSS}	Gate-Source Voltage		±12	V
	Drain Current -Continuous	(Note 1a)	5.0	А
'D	-Pulsed		20	
D	Power dissipation (Steady State)	(Note 1a)	2.4	w
P_{D}		(Note 1b)	0.9	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	52	°C/W
$R_{\theta,IA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	145	*C/VV

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
430	FDMA430NZ	7"	8 mm	3000 units

Max

Тур

Min

Units

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Parameter

Off Characteristics								
B _{VDSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V$, $I_{D} = 250 \mu A$	30			V		
$\frac{\Delta B_{VDSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu A$, Referenced to 25°C		25.2		mV/°C		
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24V, V_{GS} = 0V,$			1	μΑ		
I _{GSS}	Gate-Body Leakage,	$V_{GS} = \pm 12V, \ V_{DS} = 0V$			±10	μА		

Test Conditions

On Characteristics (Note 2)

Symbol

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6	0.81	1.5	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C		-3.2		mV/°C
	Static Drain-Source On-Resistance	$V_{GS} = 4.5V, I_D = 5.0A$		23.6	40	mΩ
		$V_{GS} = 4.0V, I_D = 5.0A$		23.9	41	
R _{DS(ON)}		$V_{GS} = 3.1V, I_D = 4.5A$		25.4	43	
DS(ON)		$V_{GS} = 2.5V, I_{D} = 4.5A$		27.6	50	11132
		$V_{GS} = 4.5V, I_D = 5.0A,$ $T_J = 150$ °C		37.0	61	
9 _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 5.0A$		25.6		S

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 10V, V_{GS} = 0V,$	600	800	pF
C _{oss}	Output Capacitance	f = 1.0MHz	110	150	pF
C _{rss}	Reverse Transfer Capacitance		75	115	pF
R_G	Gate Resistance	f = 1.0MHz	3.5		Ω

Switching Characteristics (Note 2)

t _{d(on)}	Turn-On Delay Time		8.3	17	ns
t _r	Turn-On Rise Time	$V_{DD} = 10V, I_{D} = 1A$	7.1	15	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 4.5V$, $R_{GEN} = 6\Omega$	18.1	37	ns
t _f	Turn-Off Fall Time		6.0	12	ns
Q_g	Total Gate Charge	V 40V L 5.0A	7.3	11	nC
Q_{gs}	Gate-Source Charge	$V_{DS} = 10V, I_D = 5.0A,$ $V_{GS} = 4.5V$	0.8	2	nC
Q_{gd}	Gate-Drain Charge	VGS = 4.3 V	1.9	3	nC

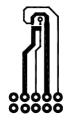
Drain-Source Diode Characteristics and Maximum Ratings

Is	Maximum Continuous Drain-Source Dio	Maximum Continuous Drain-Source Diode Forward Current			2.0	Α
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 2.0A$		0.69	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 5.0A,$			17	ns
Q_{rr}	Diode Reverse Recovery Charge	di/dt = 100A/μs			5	nC

Notes: 1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.



a. 52 °C/W when mounted on a 1 in² pad of 2 oz copper.



b. 145 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0% 3. The diode connected between the gate and the source serves only as proection against ESD. No gate overvoltage rating is implied.

Typical Characteristics T_J = 25°C unless otherwise noted

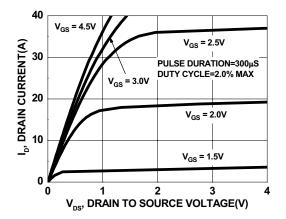


Figure 1. On Region Characteristics

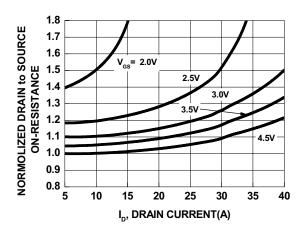


Figure 2. On-Resistance vs Drain Current and Gate Voltage

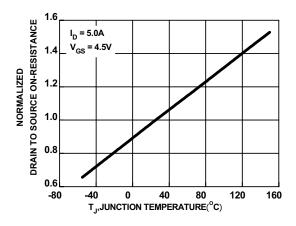


Figure 3. Normalized On Resistance vs Junction Temperature

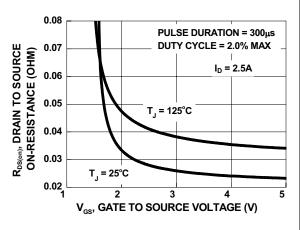


Figure 4. On-Resistance vs Gate to Source Votlage

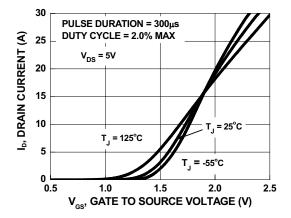


Figure 5. Transfer Characteristics

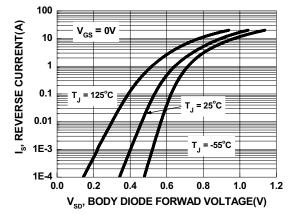
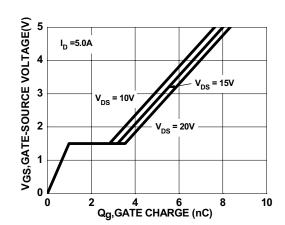


Figure 6. Source to Drain Diode Forward Voltage vs Source Current



Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

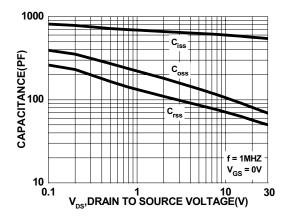
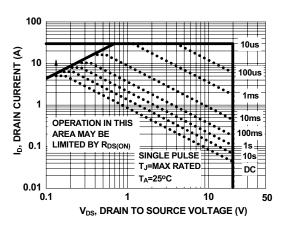


Figure 7. Gate Charge Characteristics

Figure 8. Capacitance vs Drain to Source Voltage



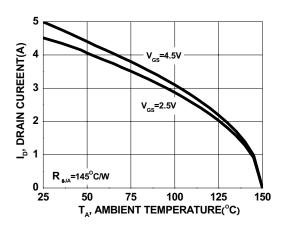


Figure 9. Safe Operating Area

Figure 10. Maximum Continuous Drain Current vs
Ambient Temperature

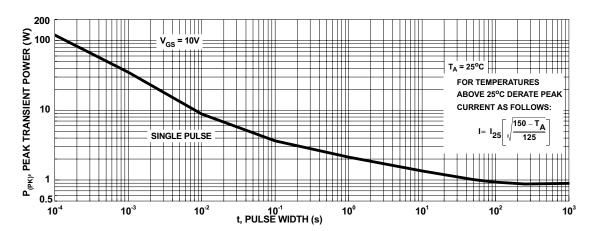


Figure 11. Single Pulse Maximum Power Dissipation

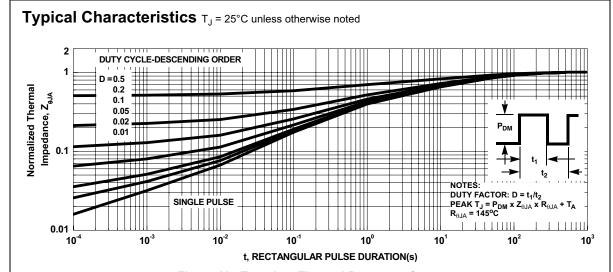
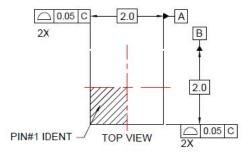
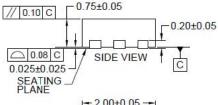
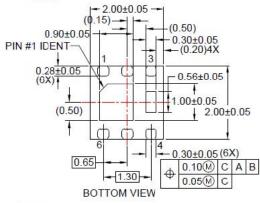


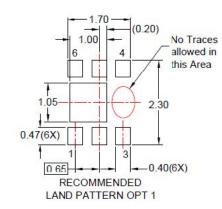
Figure 12. Transient Thermal Response Curve

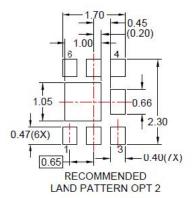
Dimensional Outline and Pad Layout











NOTES:

- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC MO-229 REGISTRATION
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP06Lrev4.

Package drawings are provided as a service to customers considering ON Semiconductor components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a ON Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of ON Semiconductor's worldwide terms and conditions, specifically the warranty therein, which covers ON Semiconductor products.

ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B